# **HD74AC174**

Hex D-Type Flip-Flop with Master Reset

# **HITACHI**

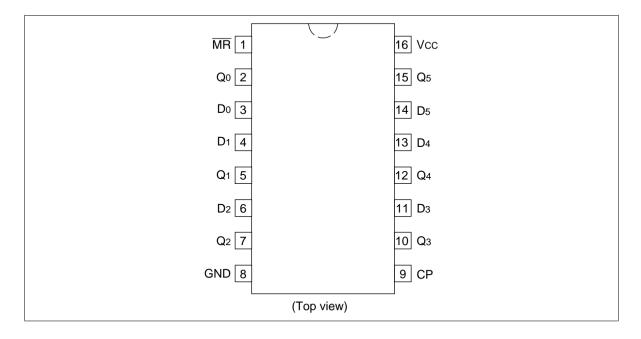
### **Description**

The HD74AC174 is a high-speed hex D flip-flop. The device is used primarily as a 6-bit edge-triggered storage register. The information on the D inputs is transferred to storage during the Low-to-High clock transition. The device has a Master Reset to simultaneously clear all flip-flops.

#### **Feature**

• Outputs Source/Sink 24 mA

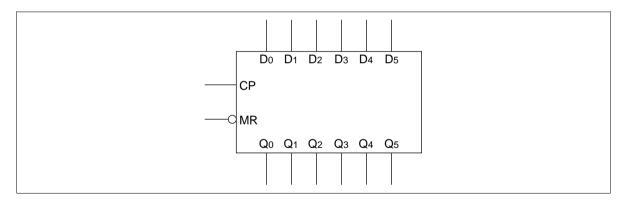
### **Pin Arrangement**





## **HD74AC174**

### **Logic Symbol**



#### Pin Names

 $D_0$  to  $D_5$  Data Inputs

 $Q_0$  to  $Q_5$  Outputs

### **Functional Description**

The HD74AC174 consists of six edge-triggered D flip-flops with individual D inputs and Q outputs. The Clock (CP) and Master Reset ( $\overline{MR}$ ) are common to all flip-flops. Each D input's state is transferred to the corresponding flip-flops's output following the Low-to-High Clock (CP) transition. A Low input to the Master Reset ( $\overline{MR}$ ) will force all outputs Low independent of Clock or Data inputs. The HD74AC174 is useful for applications where the true output only is required and the Clock and Master Reset are common to all storage elements.

#### **Truth Table**

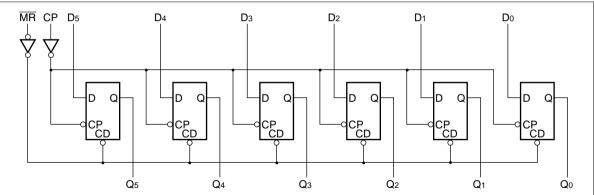
Inputs			Output	
MR	СР	D	Q	
L	Х	Х	L	
Н		Н	Н	
Н	$\int$	L	L	
Н	L	Х	Q	

H: High Voltage LevelL: Low Voltage Level

X : Immaterial

ot : Low-to-High Transition of Clock

## Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

## **DC Characteristics** (unless otherwise specified)

Item	Symbol	Max	Unit	Condition
Maximum quiescent supply current	I <sub>cc</sub>	80	μΑ	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5 \text{ V}$ , Ta = Worst case
Maximum quiescent supply current	I <sub>cc</sub>	8.0	μΑ	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5 \text{ V}$ , Ta = 25°C

### **AC Characteristics: HD74AC174**

			Ta = +25°C C <sub>L</sub> = 50 pF			Ta = $-40^{\circ}$ C to $+85^{\circ}$ C C <sub>L</sub> = 50 pF		
Item	Symbol	V <sub>cc</sub> (V)*1	Min	Тур	Max	Min	Max	Unit
Maximum clock	f <sub>max</sub>	3.3	90	100	_	70	_	MHz
frequency		5.0	100	125	_	100	_	
Propagation delay	t <sub>PLH</sub>	3.3	1.0	9.0	11.5	1.0	12.5	ns
CP to Q <sub>n</sub>		5.0	1.0	6.0	8.5	1.0	9.5	
Propagation delay	t <sub>PHL</sub>	3.3	1.0	8.5	11.0	1.0	12.0	ns
CP to Q <sub>n</sub>		5.0	1.0	6.0	8.0	1.0	9.0	
Propagation delay	t <sub>PHL</sub>	3.3	1.0	9.0	11.5	1.0	12.5	ns
$\overline{\text{MR}}$ to $Q_n$		5.0	1.0	7.0	9.0	1.0	10.5	

Note: 1. Voltage Range 3.3 is  $3.3 \text{ V} \pm 0.3 \text{ V}$ Voltage Range 5.0 is  $5.0 \text{ V} \pm 0.5 \text{ V}$ 

# **HD74AC174**

# **AC Operating Requirements: HD74AC174**

			Ta = +25°C C <sub>L</sub> = 50 pF		Ta = -40°C to +85°C C <sub>L</sub> = 50 pF	
Item	Symbol	V <sub>cc</sub> (V)*1	Тур	Guaranteed	Minimum	Unit
Setup time, HIGH or LOW	t <sub>su</sub>	3.3	2.5	6.5	7.0	ns
D <sub>n</sub> to CP		5.0	2.0	5.0	5.5	
Hold time, HIGH or LOW	t <sub>h</sub>	3.3	1.0	3.0	3.0	ns
D <sub>n</sub> to CP		5.0	0.5	3.0	3.0	<del>_</del>
MR pulse width, LOW	t <sub>w</sub>	3.3	1.0	5.5	7.0	ns
		5.0	1.0	5.0	5.0	
CP pulse width	t <sub>w</sub>	3.3	1.0	5.5	7.0	ns
		5.0	1.0	5.0	5.0	<del>_</del>
Recovery time	t <sub>rec</sub>	3.3	0	2.5	2.5	ns
MR to CP		5.0	0	2.0	2.0	<del>-</del>

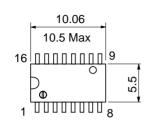
Note: 1. Voltage Range 3.3 is  $3.3 \text{ V} \pm 0.3 \text{ V}$ Voltage Range 5.0 is  $5.0 \text{ V} \pm 0.5 \text{ V}$ 

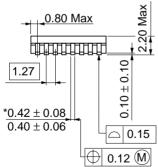
# Capacitance

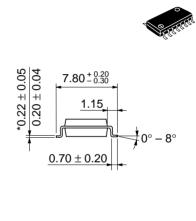
Item	Symbol	Тур	Unit	Condition
Input capacitance	C <sub>IN</sub>	4.5	pF	V <sub>CC</sub> = 5.5 V
Power dissipation capacitance	$C_{\scriptscriptstyle{PD}}$	85.0	pF	V <sub>CC</sub> = 5.0 V

Unit: mm 19.20 20.00 Max 16 7.40 Max 6.30 1.3 1.11 Max 7.62 5.06 Max 2.54 Min 0.51 Min  $0.25^{+0.13}_{-0.05}$  $0.48 \pm 0.10$  $2.54\pm0.25$  $0^{\circ} - 15^{\circ}$ Hitachi Code DP-16 **JEDEC** Conforms EIAJ Conforms Weight (reference value) 1.07 g

Unit: mm



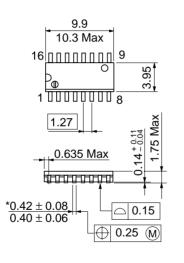


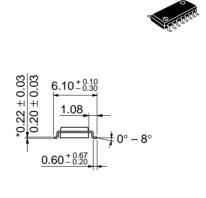


*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DA
JEDEC	_
EIAJ	Conforms
Weight (reference value)	0.24 g

Unit: mm

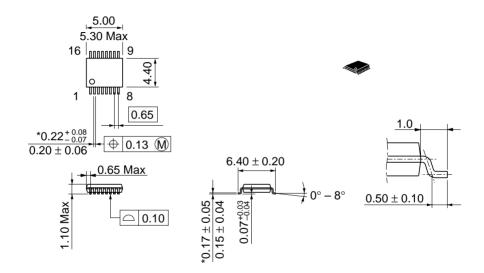




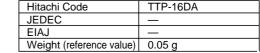
\*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

Unit: mm



\*Dimension including the plating thickness
Base material dimension



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